

Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

(Insert Title) PLASMA DENSITY INFORMATION MEASURING METHOD, PROBE USED FOR MEASURINGPLASMA DENSITY INFORMATION, AND PLASMA DENSITY INFORMATION MEASURING APPARATUS

the specification of which is attached hereto unless the following box is checked:

- ☐ was filed on _____ as United States Application Number or PCT International Application Number _____ and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. §1.56.

I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate or PCT International Application having a filing date before that of the application(s) for which priority is claimed:

| | | | | |
|--|---------------------|--------------|------------------------|---|
| (List prior foreign applications. See note A on back of this page) | <u>10-208129(P)</u> | <u>Japan</u> | <u>23/7/1998</u> | Priority Claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No |
| | (Number) | (Country) | (Day/Month/Year Filed) | |
| | <u>11-58636(P)</u> | <u>Japan</u> | <u>3/3/1999</u> | <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No |
| | (Number) | (Country) | (Day/Month/Year Filed) | |
| | _____ | _____ | _____ | <input type="checkbox"/> Yes <input type="checkbox"/> No |
| | (Number) | (Country) | (Day/Month/Year Filed) | |

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below.

| | |
|----------------------|---------------|
| _____ | _____ |
| (Application Number) | (Filing Date) |
| _____ | _____ |
| (Application Number) | (Filing Date) |

(See Note B on back of this page)

- ☐
- See attached list for additional prior foreign or provisional applications.

I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s) or §365(c) of any PCT International application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) (U.S. or PCT) in the manner provided by the first paragraph of 35, U.S.C. §112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. §1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

(List prior U.S. Applications or PCT International applications designating the U.S.)

| | | |
|--------------------------|---------------|---|
| _____ | _____ | _____ |
| (Application Serial No.) | (Filing Date) | (Status) (patented, pending, abandoned) |
| _____ | _____ | _____ |
| (Application Serial No.) | (Filing Date) | (Status) (patented, pending, abandoned) |

And I hereby appoint as principal attorneys David T. Nikaido, Reg. No. 22,663; Charles M. Marmelstein, Reg. No. 25,895; George E. Oram, Jr., Reg. No. 27,931; Robert B. Murray, Reg. No. 22,980; Martin S. Postman, Reg. No. 18,570; E. Marcie Emas, Reg. No. 32,131; Douglas H. Goldhush, Reg. No. 33,125; Kevin C. Brown, Reg. No. 32,402; Monica Chin Kitts, Reg. No. 36,105; and Richard J. Berman, Reg. No. 39,107.

Please direct all communications to the following address: **NIKAIIDO, MARMELESTEIN, MURRAY & ORAM LLP**
Metropolitan Square
655 Fifteenth Street, N.W., Suite 330 - G Street Lobby
Washington, D.C. 20005-5701
(202) 638-5000 Fax: (202) 638-4810

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. (Day/Month/Year)

(See Note C on back of this page)

Full name of sole or first inventor Hideo SUGAI
 Inventor's signature Hideo Sugai July 2, 1999
 Residence 4-6, Nakashinmachi 2-chome, Kasugai-shi, Aichi-ken 486-0956, Japan
 Citizenship Japanese
 Post Office Address same as Residence

(Day/Month/Year)

Full name of second joint inventor, if any Seiichi TAKASUGA
Inventor's signature S. Takasuga 1/7/1999
Residence c/o NISSIN Inc., 10-7, Kamei-cho, Takarazuka-shi, Hyogo-ken 665-0047, Japan
Citizenship Japanese S. Takasuga
Post Office Address same as Residence

Full name of third joint inventor, if any Naoki TOYODA
Inventor's signature N. Toyoda 1/7/1999
Residence c/o NISSIN Inc., 10-7, Kamei-cho, Takarazuka-shi, Hyogo-ken 665-0047, Japan
Citizenship Japanese
Post Office Address same as Residence

Full name of fourth joint inventor, if any _____
Inventor's signature _____ Date _____
Residence _____
Citizenship _____
Post Office Address _____

Full name of fifth joint inventor, if any _____
Inventor's signature _____ Date _____
Residence _____
Citizenship _____
Post Office Address _____

Full name of sixth joint inventor, if any _____
Inventor's signature _____ Date _____
Residence _____
Citizenship _____
Post Office Address _____

Full name of seventh joint inventor, if any _____
Inventor's signature _____ Date _____
Residence _____
Citizenship _____
Post Office Address _____

Full name of eighth joint inventor, if any _____
Inventor's signature _____ Date _____
Residence _____
Citizenship _____
Post Office Address _____